L Number	Hits	Search Text	DB	Time stamp
-	1805	((118/719) or (414/939) or (156/345.31) or (156/345.32)).CCLS.	USPAT; US-PGPUB	2004/08/06 18:12
-	155	(((118/719) or (414/939) or (156/345.31) or (156/345.32)).CCLS.) and (buffer with chamber)	USPAT; US-PGPUB	2003/11/17 08:31
-	72	(((118/719) or (414/939) or (156/345.31) or (156/345.32)).CCLS.) and (buffer with chamber) and (heat$3 with chamber) and ((transfer$3 transport$3) with chamber)	USPAT; US-PGPUB	2003/11/17 08:38
-	2	(((118/719) or (414/939) or (156/345.31) or (156/345.32)).CCLS.) and imahashi.in.	USPAT; US-PGPUB	2003/11/17 09:34
-	16	("4293249" | "5002010" | "5013385" | "5127987" | "5310410" | "5314509" | "5474410" | "5512320" | "5516732" | "5525160" | "5570994" | "5609689" | "5647724" | "5730574" | "5769952" | "5778968").PN.	USPAT	2003/11/17 08:46
-	1	("5474410").PN.	USPAT; US-PGPUB	2003/11/17 09:34
-	58	(((118/719) or (414/939) or (156/345.31) or (156/345.32)).CCLS.) and (cool$3 with (transfer$4 transport$3) with (arm hand robot effector))	USPAT; US-PGPUB	2003/11/17 10:33
-	1805	((118/719) or (414/939) or (156/345.31) or (156/345.32)).CCLS.	USPAT; US-PGPUB	2003/11/17 13:09
-	53	(((118/719) or (414/939) or (156/345.31) or (156/345.32)).CCLS.) and (heat$3 with chamber with inert with gas)	USPAT; US-PGPUB	2003/11/17 13:10
-	53	(((118/719) or (414/939) or (156/345.31) or (156/345.32)).CCLS.) and (heat$3 with chamber with inert with gas)	USPAT; US-PGPUB	2003/11/17 13:49
-	22	Kojima-shigeyoshi.in. Yonemizu-Akira.in.	USPAT; US-PGPUB	2003/11/17 13:50
-	1	("6235634").PN.	USPAT; US-PGPUB	2004/08/06 18:15
-	197	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((heat$3 with chamber) same (inert$3 with (supply$3 introduc$3 inlet enter$3 entrance)))	USPAT; US-PGPUB	2004/08/06 19:41
-	12	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((heat$3 with chamber) same (wall with temperature with control$3 with independent$3))	USPAT; US-PGPUB	2004/08/08 16:38
-	528	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((heat$3 with chamber) same (cover lid))	USPAT; US-PGPUB	2004/08/06 18:45
-	166	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((heat$3 with chamber) same ((cover lid) with (lower$3 lift$3 rais$3 (move$3 with vertical$4))))	USPAT; US-PGPUB	2004/08/06 18:49
-	12	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((heat$3 adj chamber) same ((cover lid) with (lower$3 lift$3 rais$3 (move$3 with vertical$4))))	USPAT; US-PGPUB	2004/08/06 18:52
-	6056	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((seal$3 (cover lid) with (lower$3 lift$3 rais$3 (move$3 with vertical$4))))	USPAT; US-PGPUB	2004/08/06 18:52
-	184	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((seal$3 with (cover lid) with (lower$3 lift$3 rais$3 (move$3 with vertical$4))))	USPAT; US-PGPUB	2004/08/06 18:52
-	146	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((seal$3 with (cover lid) with (lower$3 lift$3 rais$3 (move$3 with vertical$4)))) and heat$3	USPAT; US-PGPUB	2004/08/06 18:53
-	2	("5505782" | "6045617").PN.	USPAT	2004/08/06 18:56
-	2	("5505782" | "6045617").PN.	USPAT	2004/08/06 18:56
-	0	6156125.URPN.	USPAT	2004/08/06 18:56

	Hits	Query	DBs	Date/Time
–	9	("5016563" | "5303671" | "5365772" | "5834737" | "6015594" | "6350316" | "6190459" | "6246030" | "6248168").PN.	USPAT	2004/08/06 19:07
–	4	6190459.URPN.	USPAT	2004/08/06 19:10
–	1	"6190459".PN.	USPAT	2004/08/06 19:11
–	0	6573031.URPN.	USPAT	2004/08/06 19:11
–	8	("5470802" | "5494858" | "5540772" | "5688565" | "5830623" | "5846597" | "5858526" | "6090209").PN.	USPAT	2004/08/06 19:12
–	9	("5016563" | "5303671" | "5365772" | "5834737" | "6015594" | "6350316" | "6190459" | "6246030" | "6248168").PN.	USPAT	2004/08/06 19:14
–	0	6501191.URPN.	USPAT	2004/08/06 19:14
–	19	("4715921" | "4733631" | "4830700" | "4832778" | "4906328" | "4915777" | "5019233" | "5076205" | "5169478" | "5205919" | "5281295" | "5281320" | "5288379" | "5292393" | "5302209" | "5308431" | "5330633" | "5364219" | "5376223").PN.	USPAT	2004/08/06 19:23
–	65	4503807.URPN.	USPAT	2004/08/06 19:24
–	13	("4209357" | "4503807" | "4624738" | "4718975" | "4816638" | "4869801" | "5044311" | "5236509" | "5620560" | "5997588" | "5998766" | "6089763" | "6488824").PN.	USPAT	2004/08/06 19:25
–	14	5620560.URPN.	USPAT	2004/08/06 19:28
–	6	("5529626" | "5620560" | "5664254" | "5937223" | "5943880" | "6215545").PN.	USPAT	2004/08/06 19:29
–	7	6341903.URPN.	USPAT	2004/08/06 19:29
–	14	5620560.URPN.	USPAT	2004/08/06 19:32
–	1	"5252807".PN.	USPAT	2004/08/06 19:32
–	26	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((heat$3 with chamber) same (inert$3 with (supply$3 introduc$3 inlet enter$3 entrance) with purg$3))	USPAT; US-PGPUB	2004/08/08 16:11
–	0	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((heat$3 adj chamber) same (inert$3 with (supply$3 introduc$3 inlet enter$3 entrance) with purg$3))	USPAT; US-PGPUB	2004/08/06 19:41
–	21	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((heat$3 adj chamber) same (inert$3 with (supply$3 introduc$3 inlet enter$3 entrance)))	USPAT; US-PGPUB	2004/08/06 19:45
–	2	(wafer substrate workpiece semiconductor) and ((heat$3 adj chamber) same (inert$3 with (supply$3 introduc$3 inlet enter$3 entrance) with purg$3))	USPAT; US-PGPUB	2004/08/06 19:46
–	118	(wafer substrate workpiece semiconductor) and ((heat$3 adj chamber) same (inert$3 with (supply$3 introduc$3 inlet enter$3 entrance)))	USPAT; US-PGPUB	2004/08/08 16:11
–	0	"09986894"	USPAT; US-PGPUB	2004/08/08 13:55
–	1	("5567381").PN.	USPAT; US-PGPUB	2004/08/08 15:13
–	14	("1699784" | "1876960" | "2446403" | "3014708" | "3399875" | "3431346" | "3522357" | "3609295" | "3866891" | "4445849" | "4647017" | "4758157" | "4932864" | "5052923").PN.	USPAT	2004/08/08 15:13
–	1	("4141539").PN.	USPAT; US-PGPUB	2004/08/08 15:13
–	6	(wafer substrate workpiece semiconductor) and ((heat$3 adj chamber) same (control$4 with inert$3 with (supply$3 introduc$3 inlet enter$3 entrance)))	USPAT; US-PGPUB	2004/08/08 16:17
–	14	(wafer substrate workpiece semiconductor) and ((heat$3 adj2 chamber) same (control$4 with inert$3 with (supply$3 introduc$3 inlet enter$3 entrance)))	USPAT; US-PGPUB	2004/08/08 16:23

–	8	((wafer substrate workpiece semiconductor) and ((heat$3 adj2 chamber) same (control$4 with inert$3 with (supply$3 introduc$3 inlet enter$3 entrance)))) not ((wafer substrate workpiece semiconductor) and ((heat$3 adj chamber) same (control$4 with inert$3 with (supply$3 introduc$3 inlet enter$3 entrance))))	USPAT; US-PGPUB	2004/08/08 16:17
–	101	(wafer substrate workpiece semiconductor) and ((heat$3 with chamber) same (control$4 with inert$3 with (supply$3 introduc$3 inlet enter$3 entrance)))	USPAT; US-PGPUB	2004/08/08 16:35
–	7	(("6168837") or ("6368954") or ("6015590") or ("4897709") or ("5348587") or ("5811762") or ("5879459")).PN.	USPAT; US-PGPUB	2004/08/08 16:36
–	9	bondestam.in.	USPAT; US-PGPUB	2004/08/08 16:37
–	32	(118/715-733.ccls. 156/345.$.ccls. 204/298.$.ccls.) and ((wall with (heat$3 temperature) with control$3 with independent$3))	USPAT; US-PGPUB	2004/08/08 16:39
–	28	(c23c016$.ipc.) and ((wall with (heat$3 temperature) with control$3 with independent$3))	USPAT; US-PGPUB	2004/08/08 16:39
–	7	(c23c016$.ipc.) and ((wall with (heat$3 temperature) with control$3 with independent$3))	EPO; JPO; DERWENT	2004/08/08 16:45
–	1	("6331212").PN.	USPAT; US-PGPUB	2004/08/08 16:45
–	1	("6331212").PN.	USPAT; US-PGPUB	2004/08/09 12:51
–	1	("5286296").PN.	USPAT; US-PGPUB	2004/08/09 12:52